

3.5x2.8 mm SMD CHIP LED LAMP

## PRELIMINARY SPEC

#### **Features**

- SINGLE COLOR.
- $\bullet$  SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- IDEAL FOR BACKLIGHTING.
- WHITE SMD PACKAGE, SILICONE RESIN.
- LOW THERMAL RESISTANCE.
- PACKAGE: 1500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 2a.
- Rohs Compliant.

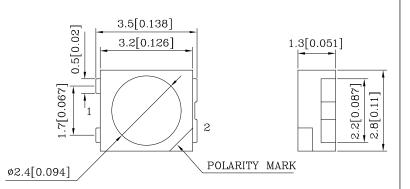


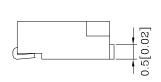


#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.25(0.01") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (TA=25°C)	DG24 ( InGaAlN)	Unit			
Forward Current	IF	150	mA		
Thermal Resistance	Rth	170	°C /W		
Power Dissipation	Рт	570	mW		
Operating Temperature	TA	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +85			







Operating Characterist (TA=25°C)	DG24 ( InGaAlN)	Unit	
Forward Voltage (Typ.) (IF=150mA)	$V_{\rm F}$	3.4	V
Forward Voltage (Max.) (IF=150mA)	$V_{\rm F}$	3.8	V
Wavelength of Peak Emission (Typ.) (IF=150mA)	λΡ	515	nm
Wavelength of Dominant Emission (Typ.) (IF=150mA)	λ D	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=150mA)	Δλ	30	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=150mA) mcd		Luminous Flux (IF=150mA) mlm		Wavelength nm λ P	Viewing Angle 2 0 1/2
				min.	typ.	min.	typ.		
ZDG24X109S	Green	InGaAlN	Water Clear	6700	7490	18000	21000	515	120°
Published Da	ate : FEB 25, 2	2008	Drawing No : S	SDSA6169	V1	C	hecked : B	.L.LIU	P.1/5

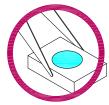
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#### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

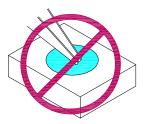
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

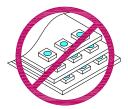


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

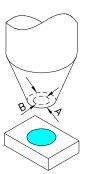




3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



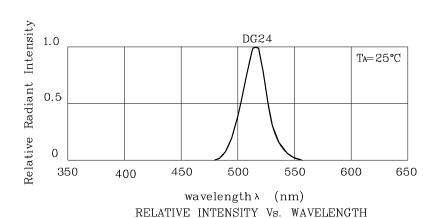
- 4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- $5.\ A\ pliable\ material\ is\ suggested\ for\ the\ nozzle\ tip\ to\ avoid\ scratching\ or\ damaging\ the\ LED\ surface\ during\ pickup.$
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



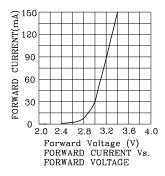
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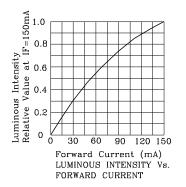


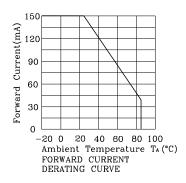
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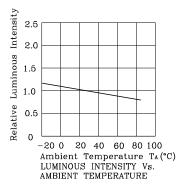


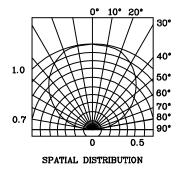
## **❖** DG24







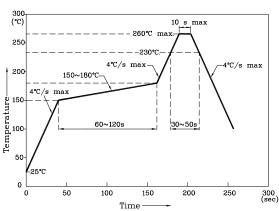




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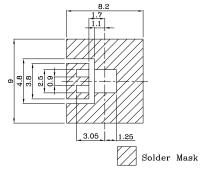
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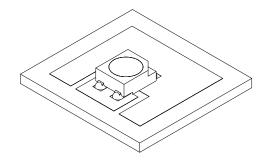
Reflow Soldering Profile For Lead-free SMT Process.



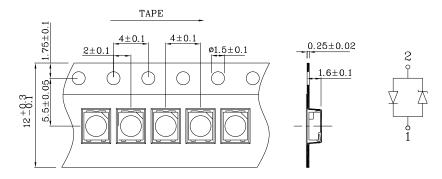
NOTES:

- Maximum soldering temperature should not exceed 260°c.
- 2. Recommended reflow temperature: 145°c-260°c.
- 3. Do not put stress to the epoxy resin during high temperatures conditions.
- **❖** Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)
- **❖** The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

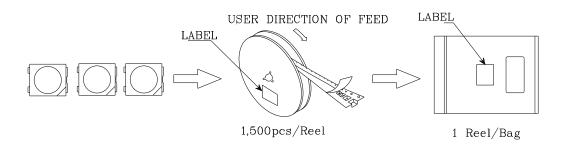
 $Published\ Date: FEB\ 25,\ 2008 \qquad \qquad Drawing\ No: SDSA6169 \qquad \qquad V1 \qquad \qquad Checked: B.L.LIU \qquad \qquad P.4/5$ 

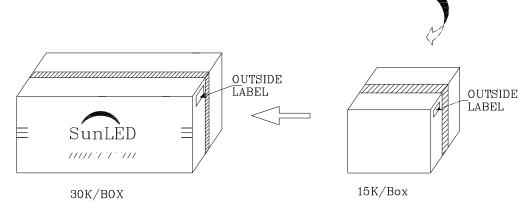


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# PACKING & LABEL SPECIFICATIONS

## **ZDG24X109S**







QTY: 1,500 pcs CODE: XXX

S/N: XX

LOT NO:



RoHS Compliant